## AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the present application.

## **Listing of Claims:**

Claim 1 (currently amended): A method of manufacturing a crystal of a group III-V compound, the method comprising:

a deposition step of depositing a metal film on a substrate;

a heat-treatment step of heat-treating the metal film under an atmosphere in which a metal-film patterning compound is present so that the metal film becomes patterned with a plurality of grooves having an indefinite shape, the grooves having an average width of 2 nm to 5000 nm, the metal film having an aperture fraction of 5% to 80%, the aperture fraction being the percentage of the surface area that the grooves occupy with respect to the substrate total surface area; and

a growth step of growing a group III-V crystal on the post-heat-treated metal film.

Claim 2 (currently amended): A method of manufacturing a crystal of a group III-V compound, the method comprising:

a deposition step of depositing a metal film on a substrate;

a heat-treatment step of heat-treating the metal film under an atmosphere in which a metal-film patterning compound is present so that the metal film becomes patterned with a plurality of grooves having an indefinite shape, the grooves having an average width of 2 nm to 5000 nm, the metal film having an aperture fraction of

5% to 80%, the aperture fraction being the percentage of the surface area that the grooves occupy with respect to the substrate total surface area;

a first growth step of growing a group III-V compound buffer film on the postheat-treated metal film; and

a second growth step of growing a group III-V crystal on the group III-V compound buffer film.

## Claim 3 (canceled)

Claim 4 (previously presented): A group III-V crystal manufacturing method as set forth in claim 1, characterized in that the substrate is silicon, sapphire, SiC, ZrB<sub>2</sub>, or a group III-V compound.

Claim 5 (previously presented): A group III-V crystal manufacturing method as set forth in claim 1, characterized in that the metal film contains titanium or vanadium.

Claim 6 (previously presented): A group III-V crystal manufacturing method as set forth in claim 1, wherein the method renders the thickness of the metal film to be 10 nm to 100 nm.

Claim 7 (previously presented): A group III-V crystal manufacturing method as set forth in claim 1, characterized in that the heat treatment is carried out at 800°C to 1200°C for 0.5 minutes to 20 minutes.

Claim 8 (previously presented): A group III-V compound crystal manufactured by a group III-V crystal manufacturing method as set forth in claim 1.

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Claim 9 (previously presented): A group III-V compound crystal as set forth in claim 8, wherein the group III-V crystal is  $Ga_xAl_yIn_{1-x-y}$  ( $0 \le x \le 1$  and  $0 \le y \le 1$ ).

Claim 10 (canceled)

Claim 11 (previously presented): A group III-V crystal manufacturing method as set forth in claim 2, characterized in that the substrate is silicon, sapphire, SiC, ZrB<sub>2</sub>, or a group III-V compound.

Claim 12 (previously presented): A group III-V crystal manufacturing method as set forth in claim 2, characterized in that the metal film contains titanium or vanadium.

Claim 13 (previously presented): A group III-V crystal manufacturing method as set forth in claim 2, wherein the method renders the thickness of the metal film to be 10 nm to 100 nm.

Claim 14 (previously presented): A group III-V crystal manufacturing method as set forth in claim 2, characterized in that the heat treatment is carried out at 800°C to 1200°C for 0.5 minutes to 20 minutes.

Claim 15 (previously presented): A group III-V compound crystal manufactured by a group III-V crystal manufacturing method as set forth in claim 2.

Claim 16 (previously presented): A group III-V compound crystal as set forth in claim 15, wherein the group III-V crystal is  $Ga_xAl_yIn_{1-x-y}$  ( $0 \le x \le 1$  and  $0 \le y \le 1$ ).